# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## GP2W1001YP

#### Features

- 1. Integrated package of light emitter and receiver. (10.0×4.4×H3.5 mm)
- 2. Low profile type (Height:3.5 mm)
- 3. Compliant with IrDA1.0 and IrDA1.1
- 4. Low voltage operation type (Supply voltage:2.4V to 5.5V)
- 5. Low dissipation current thanks to power down mode (Dissipation current at shut-doen mode:Max.  $1\mu A$ )
- 6. Applicable for reflow soldering
- 7. With shield case

#### Applications

- 1. Personal computers
- 2. Personal information tools

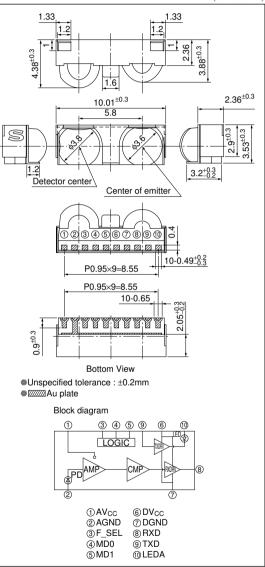
■ Absolute Maximum Ratings (Ta=25°C						
Parameter	Symbol	Rating	Unit			
Supply voltage	Vcc	6	V			
Transmission signal duty ratio	TXduty	50	%			
Operating temperature	Topr	-10 to +70	°C			
Storage temperature	Tstg	-20 to +85	°C			

Note) Transmission signal duty ratio show the time share of H level of transmission wave at TX terminal. The frequency shall be 1kHz or more.

#### Low Profile Type IrDA Transceiver Module Compliant with IrDA1.1

#### ■ Outline Dimensions

(Unit : mm)



#### ■ Recommended Operating Conditions (Ta=25°C)

Parameter	Symbol	Rating	Unit
Operating Supply voltage	Vcc	2.7 to 5.5	V
Operating temperature	Topr	0 to +70	°C
SIR bit rate	-	9.6 to 115.2	kbps
FIR bit rate	-	1.152/4	Mbps

#### ■ Electro-optical Characteristics (Ta=25±3°C, Vcc=3.3±0.1V, 5±0.1V, Ambient illuminance of detecting face: 1001x or less)

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
_	Dissipation current at no input signal		Icc	RXOUT:H, TXIN:L, Vcc=3.3V	-	-	1.2	mA
			Icc	RXOUT:H, TXIN:L, Vcc=5.0V		_	1.5	mA
	S/D dissipation current		Iccs	RXOUT:H, TXIN:L, Vcc=3.3V	-	0.1	1	μΑ
				RXOUT:H, TXIN:L, Vcc=5.0V	-	0.2	2	μA
	Dissipation current	nt	Iccp	Peak Value, Vcc=3.3V (2.4Ω), 5.0V (6.8Ω)	-	400	600	mA
	Switching time (Shut dow	wn to stand by)	trsd		-	-	1.5	ms
	Receiver sensitivi	ty	Srx0	SIR:9.6k to 115.2kbps	0.04	-	5 000	W/m <sup>2</sup>
	(-15	°≤θ≤+15°)	Srxθ	FIR:1.152M/4Mbps	0.01	-	5 000	W/m <sup>2</sup>
ide	Low level output	voltage	Vol	Vcc=3.3, 5.0V	-	-	0.4	V
ers	High level output	voltage	Vон	Vcc=3.3, 5.0V	Vcc-0.4	-	-	V
Receiver side	Rise time		trrA	SIR:9.6k to 115.2kbps	-	-	200	ns
Rec	Rise time		trrB	FIR:1.152M/4Mbps	-	-	40	ns
	Fall time		tfrA	SIR:9.6k to 115.2kbps	-	-	200	ns
	r'an unic		<b>t</b> frB	FIR:1.152M/4Mbps	-	-	40	ns
	Peak sensitivity w	vavelength	λrx		-	940	-	nm
			tw1	SIR:Pulse width 19.53µs(9.6kbps), Duty 3/16	1	-	22	μs
			tw2	SIR:Pulse width 1.63µs(115.2kHz), Duty 3/16	1	_	3	μs
	Low level pules v	vidth	tw3	FIR:Pulse width 217ns(1.152Mbps), Duty 1/4	110	-	500	ns
			tw4	FIR:Pules width Single 125ns(4Mbps), Duty 1/4	85	-	165	ns
			tw5	FIR:Pules width Double 250ns(4Mbps), Duty 1/4	210	_	290	ns
	Peak emission wa	welength	$\lambda_{tx}$		850	880	900	nm
	Radiant intensity	ф=0°	Ielo	Low Power	-	15	-	mW/sr
e		ф=0°	Іемо	Middle Power	-	60	-	mW/sr
sid		-15°≤¢≤+15°	Iefθ	Full Power	100	-	500	mW/sr
itter	E Low level input voltage		VIL	Vcc=3.3, 5.0V	-	-	Vcc×0.2	V
smi	$\begin{array}{c c} \hline & & & \\ \hline \\ \hline$		VIH	Vcc=3.3, 5.0V	Vcc×0.2	-	-	V
lran	TXin terminal inp	out current	Ін	TXIN=Vcc=5.0V	-	-	50	μΑ
Ľ			IIL	TXIN=GND	-0.1	0	0.1	μΑ
	Transmission sign		trtx		-	-	40	ns
	Transmission sign	al fall time	t <sub>ftx</sub>		-	-	40	ns

#### ■ Truth Table

Inj	put	Output		
TXD (Transmitter)	*1 Receiver	State of LED (Transmitter)	RXD terminal	
High	-	ON	X	
Low	ON	OFF	Low	
Low	OFF	OFF	High	

X:Do not care

\*1 External optical signal receiving state of photodiode

#### ■ Input Output Logic Table

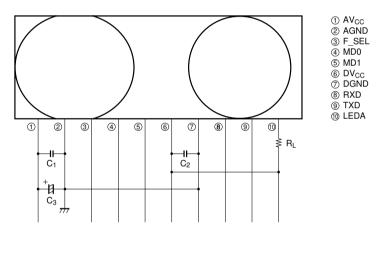
MD0	MD1	F_SEL	TXD	RXD terminal mode	TXO *2	Remarks
1	0	X	0	Shut down	Shut down	-
	0	1	0	RXA	Х	Latch TXD *1
	0	1	1	RXB	Х	Latch TXD <sup>*1</sup>
0	0	0	X	RXA	HPW	TXO Output High Power mode
0	1	0	X	$\downarrow$	MPW	TXO Output Middle Power mode
1	1	0	X	$\downarrow$	LPW	TXO Output Low Power mode
0	0	1	X	RXB	HPW	TXO Output High Power mode
0	1	1	X	$\downarrow$	MPW	TXO Output Middle Power mode
1	1	1	X	$\downarrow$	LPW	TXO Output Low Power mode

\*1 F\_SFL → 0:reset latching state of TXD, and turn to RXA channel. RXA:RXA channel mode:115kbps or less (SIR 115.2kbps, 9 600bps)

RXB:RXB channel mode:115kbps or more (FIR 1.152Mbps, 4Mbps)

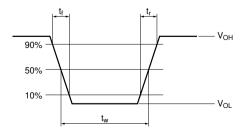
\*2 LED operating mode

#### Fig.1 Recommended External Circuit



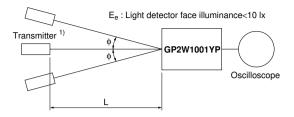
Components	Recommended values		
C1•C2	1µF±10% (Note 1)		
C <sub>3</sub>	4.7µF±10% (Note 2)		
	2.4Ω±5% 1/2W		
Р	(V <sub>CC</sub> =3.3V)		
RL	6.8Ω±5% 1/2W		
	(V <sub>CC</sub> =5V)		
(Note 1) Pleas	se locate nearby this		
trans	ceiver choosing the ceramic		
capa	citor with higher frequency		
featu	re		
(Note 2) Pleas	e choose the most suitable		
C <sub>X</sub> ad	C <sub>X</sub> according to the noise level		
and r	and noise frequency of power		
0.101			

#### Fig.2 Output Waveform Specification(Receiver side)(CL≤10pF)



#### SHARP

#### Fig.3 Standard Optical System(Receiver side)

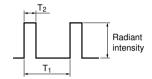


Transfer rate	T <sub>1</sub>	T <sub>2</sub>	$T_2/T_1$	Radiant intensity
9.6kbps	104µs	19.53µs	3/16	40mW/sr
115.2kbps	8.68µs	1.63µs	3/16	40mW/sr
1.152Mbps	868ns	217ns	1/4	100mW/sr
4Mbps (S)	500ns	125ns	1/4	100mW/sr
4Mbps (W)	1 000ns	250ns	1/4	100mW/sr

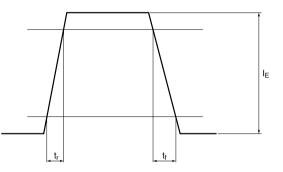
 $\boldsymbol{\phi}$  : Indicates horizontal and vertical directions.

The light emitting diode (SHARP GL710,  $\lambda p$ =850 to 900nm) is used as the transmitter, where the following continuous signals are transmitted.

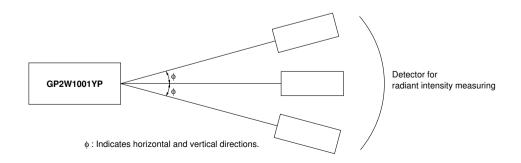
In Fig.3, output signal shall be complete receiver side electro-optical characteristics.



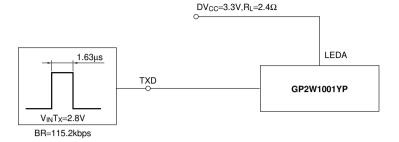
#### Fig.4 Output Waveform Specification(Transmitter side)



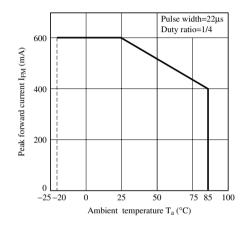
#### Fig.5 Standard Optical System(Transmitter side)



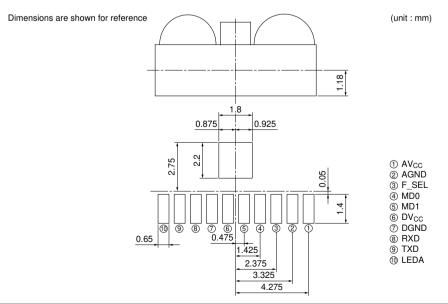
#### Fig.6 Recommended Circuit of Transmitter side



#### Fig.7 Peak Forward Current vs. Ambient Temperature

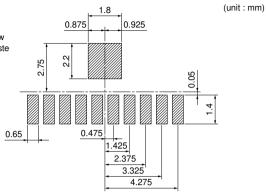


#### Fig.8 Recommended PCB Foot Pattern



#### Fig.9 Recommended Size of Solder Creamed Paste (Reference)

Dimensions are shown for reference. Please open the solder mask as below so that the size of solder creamed paste for this device before reflow soldering must be as large as one of the foot pattern land indicated at Fig.8



Solder paste area

#### NOTICE

- •The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- •Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- •Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
  - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
  - Personal computers
  - Office automation equipment
  - Telecommunication equipment [terminal]
  - Test and measurement equipment
  - Industrial control
  - Audio visual equipment
  - Consumer electronics

(ii)Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii)SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).
- •Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
- •If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Control Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- •This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- •Contact and consult with a SHARP representative if there are any questions about the contents of this publication.